DECLARATION FOR PATENT APPLICATION (JOINT OR SOLE) (Under 37 CFR § 1.63; with Power of Attorney)

FROMMER LAWRENCE & HAUG LLP

FLH File No. 450100-03426

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name,

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention EMITILED:

NETWORK ERROR DISPLA	Y APPARATUS AND ERROR DETI	ECTION DISPLAY METHOD	
the specification of which			
_X is attached hereto.			
was filed on	as Application Serial No		
with amendment(s) through		if applicable, give dates).	
the claims, as amended by any amendment refe I acknowledge the duty to disclose to be material to patentability as defined I I hereby claim foreign priority ben for patent or inventor's certificate listed inventor's certificate having a filing date Prior Foreign Application(s) [I Number: Cour	erred to above. to the United States Patent and Trr n Title 37, Code of Federal Regula efits under Title 35, United State below and have also identified bel	s Code, § 119 of any foreign application(s) tow any foreign application for patent or which priority is claimed: rate page]: Priority Claimed: th/Year): Yes No	
I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) listed below and, innodar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code § 112, I acknowledge the daity to disclose to the United States Patent and Irandemark Office all information known to me to material to distentability as defined in Title 37, Code of Federal Regulations, Sec. 1.56, which became available between the filing date of the prior application and the national or PCI international filing date of this application. Prior U.S. Application(s) List additional applications on separate pagel: Appln. Ser. Number: Filed (Day/Honth/Year): Status (Epstented, pending, abandomed): I hereby appoint MILLIAM S. FROMMER, Registration No. 25,506, and DENNIS M. SMID, Registration No. 34,730 options of the patent and divisional applications and manchements therein, to file continuation and divisional applications thereof, to receive the Patent and to transact all business in the Patent and irrademark Office and in the Caution thereof, to receive the Patent and to transact all business in the Patent and irrademark Office and in the Caution to the Patent and irrademark Office and in the Caution School C			
I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.			
INVENTOR(S): Signature:		Dates	
Full name of sole or first inventor: Residence: Citizenship: P.O. Address:	Yukihiko AOKI Tokyo, Japan Japan Sony Corporation 7-35, Kitashinagawa 6-Chome, Shinagawa-Ku, Tokyo, Japan		
Signature:	Yoshiaki TAKENAKA	Date:	
Residence: Citizenship: P.O. Address:	Tokyo, Japan Japan Sony Corporation 7-35, Kitashinagawa 6-Chome, Shinagawa-Ku, Tokyo, Japan		
[Similarly list additional inventors on sepa Post Office Address(es) of inventor(s): [if all inventors have the same post office	· ·		
Note: In order to qualify for reduced fees having rights to the invention must also sig Supporting a Claim by Another for] Small Ent Nonprofit Organization, individual Non-Inver	n an appropriate separate "Verific ity Status" form [e.g. for Indeper	ed Statement (Declaration) Claiming [or	

Note: A post office address must be provided for each inventor.

Signature:	No.	te:
Full name of 3rd joint inventor (if any): Residence: Citizenship: P.O. Address:	Haruyuki MIURA Kanagawa, Japan Japan Sony Corporation	
	7-35, Kitashinagawa 6-Chome,	
	Shinagawa-Ku, Tokyo, Japan	
Signature:	Da	te:
Full name of 4th joint inventor (if any):	Shinobu OHASHI	
Residence:	Ibaraki, Japan	
Citizenship:	Japan	
P.O. Address:	SONY EMCS CORPORATION SHIMOTSUMA TEC	
	423. Shimotsumahei, Shimotsuma-Shi,	
	Ibaraki-Ken, Japan	